

SBM540

5A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER POWERMITE 3

Features

Guard Ring Die Construction for Transient Protection

Low Power Loss, High Efficiency

Low Forward Voltage Drop

For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications

Lead Free Finish, RoHS Compliant (Note 2)

Mechanical Data

Case: POWERMITE 3

Case Material: Molded Plastic. UL Flammability

Classification Rating 94V-0

Moisture Sensitivity: Level 1 per J-STD-020C

Terminals: Solderable per MIL-STD-202, Method 208

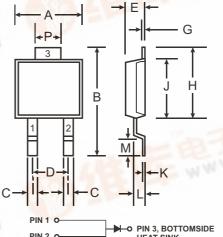
Lead Free Plating (Matte Tin Finish). (63)

Polarity: See Diagram

Marking: Type Number, See also Sheet 3

Ordering Information, See Sheet 3

Weight: 0.072 grams (approximate)



PIN 1 O
PIN 2 O
PIN 3, BOTTOMSIDE
HEAT SINK

Pins 1 & 2 must be electrically
connected at the printed circuit board.

POWERMITE 3					
Dim	Min	Max			
Α	4.03	4.09			
В	6.40	6.61			
С	.889 NOM				
D	1.83 NOM				
E	1.10	1.14			
G	.178 NOM				
H	5.01	5.17			
J	4.37 4.43				
K	K .178 NOM				
L	.71	.77			
M	.36 .46				
Р	1.73	1.83			
All Dimensions in mm					

Maximum Ratings @ T_A = 25 C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

Characteristic	Symbol	Value	Unit V	
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	40		
RMS Reverse Voltage	V _{R(RMS)}	28	V	
Average Rectified Output Current (see also Figure 5)	Io	5	А	
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load @ T _C = 90 C	I _{FSM}	100	A	
Typical Thermal Resistance Junction to Soldering Point	R JS	3.2	C/W	
Operating Temperature Range	Tj	-55 to +125	С	
Storage Temperature Range	T _{STG}	-55 to +150	°C	

Note:

Electrical Characteristics @ T_A = 25 C unless otherwise specified

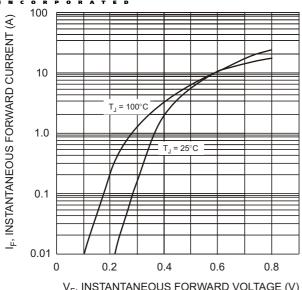
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 1)	V _{(BR)R}	40			V	$I_R = 0.5 \text{mA}$
Forward Voltage	V _{FM}		0.48 0.45 0.59 0.56	0.52	V	$\begin{array}{l} I_F = 5A, \ T_S = \ 25 \ C \\ I_F = 5A, \ T_S = 125 \ C \\ I_F = 10A, \ T_S = 25 \ C \\ I_F = 10A, \ T_S = 125 \ C \\ \end{array}$
Reverse Current (Note 1)	I _{RM}		0.05 2.5	0.5 20	mA	T _S = 25 C, V _R = 40V T _S = 100 C, V _R = 40V
Total Capacitance	Ст		250		pF	f = 1.0MHz, V _R = 4.0V DC

RoHS revision 13.2.2003. High Temperature Solder Exemption Applied, see EU Directive Annex Note 7.

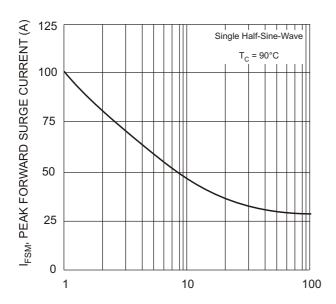
Short duration test pulse used to minimize self-heating effect.

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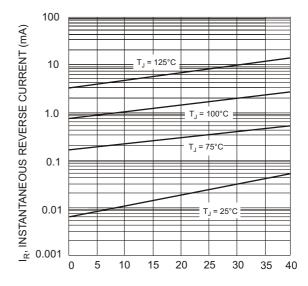
DIODES



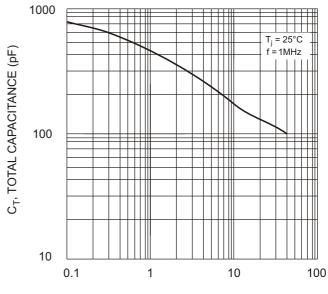
V_F, INSTANTANEOUS FORWARD VOLTAGE (V) Fig. 1 Typical Forward Characteristics



NUMBER OF CYCLES AT 60 Hz Fig. 3 Max Non-Repetitive Peak Forward Surge Current

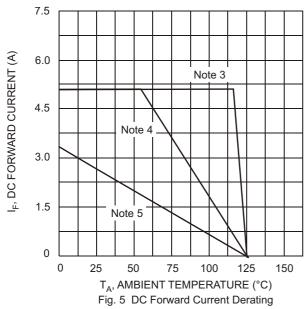


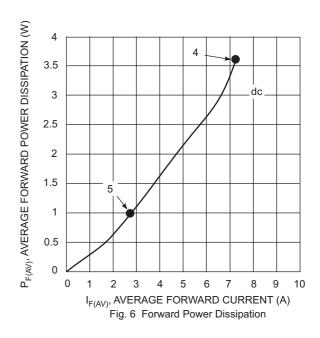
V_R, INSTANTANEOUS REVERSE VOLTAGE (V) Fig. 2 Typical Reverse Characteristics



V_R, REVERSE VOLTAGE (V) Fig. 4 Typical Total Capacitance vs. Reverse Voltage

DIODES





Notes:

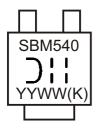
- 3. $T_A = T_{SOLDERING\ POINT}$, R $_{JS} = 3.2\ C/W$, R $_{SA} = 0\ C/W$.
- 4. Device mounted on GETEK substrate, 2"x2", 2 oz. copper, double-sided, cathode pad dimensions 0.75" x 1.0", anode pad dimensions 0.25" x 1.0". R JA in range of 15-30°C/W.
- Device mounted on FR-4 substrate, 2"x2", 2 oz. copper, single-sided, pad layout as per Diodes Inc. suggested pad layout document AP02001 which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf. R JA in range of 60-75°C/W.

Ordering Information (Note 6)

Device	Packaging	Shipping
SBM540-13-F	POWERMITE 3	5000/Tape & Reel

Notes: 6. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



SBM540 = Product type marking code
O!! = Manufacturers' code marking
YYWW = Date code marking
YY = Last digit of year ex: 02 for 2002
WW = Week code 01 to 52
(K) = Factory Designator

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